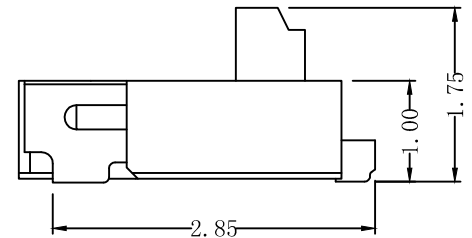
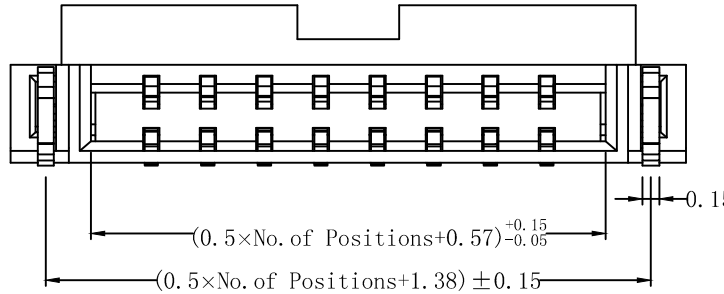
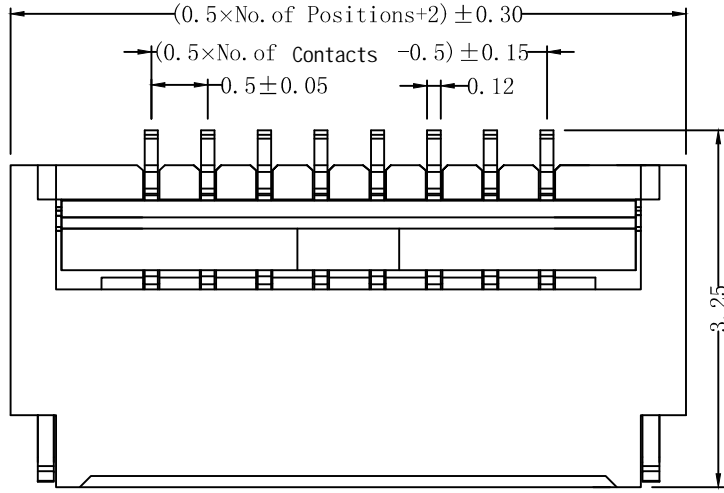
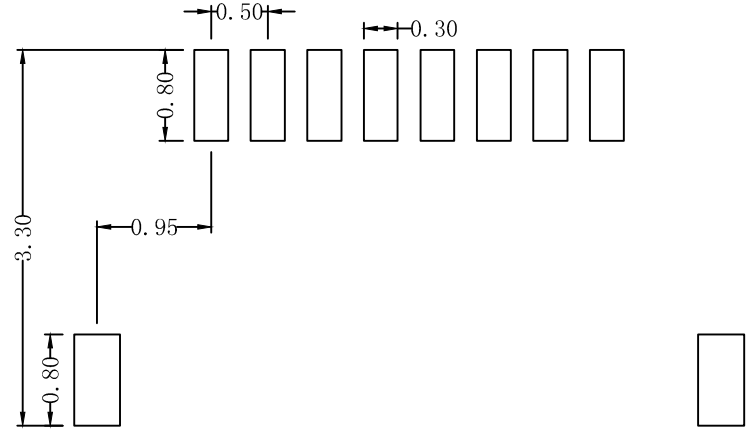


REV	DESCRIPTION	DATE



NOTE:

- MATERIAL
 HOUSING:HIGH-TEMP, THERMOPLASTIC, UL 94V-0.
 CONTACT:COPPER ALLOY.
 PLATING:TIN OR GOLD PLATED OVER NICKEL.
 HOLDDOWN:COPPER ALLOY.
 PLATING:TIN OR GOLD PLATED OVER NICKEL.
- PART NO.
 CNT-FPC050-XX-TDM-D30-100



RECOMMENDED PCB LAYOUT

CNT 肯耐特电子有限公司				GENERAL TOLERANCE		DRAWN 董道丽		DATE 20191011		DWG. NO.		TITLE	
				X.° ±5°	X. ±0.30	CHECK 王芳芳		DATE 20191011		PART. NO.		FPC pitch 0.5mm 双面接触 前插 后锁 掀盖式SMT90度 (H=1.0mm)	
.X° ±3°	.X ±0.38	APPROVE 王元中		DATE 20191011		CNT-FPC050-XX-TDM-D30-100							
.XX° ±2°	.XX ±0.25												
.XXX° ±1°	.XXX ±0.15												
REV. 1.0	UNIT mm	SCALE 1:1											